



ALPHA & OMEGA
SEMICONDUCTOR

Alpha & Omega Semiconductor Product Reliability Report

AOZ2260BQI-15, rev A

Plastic Encapsulated Device

ALPHA & OMEGA Semiconductor, Inc

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This AOS product reliability report summarizes the qualification results for AOZ2260BQI-15 in QFN4x4_22L package. Accelerated environmental tests are performed on a specific sample size and samples are electrically tested before and after each time point. Review of final electrical test results confirm that AOZ2260BQI-15 pass the AOS quality and reliability requirements. The released products will be categorized by its process family and routinely monitored for continuous improvement of product quality.

I. Reliability Stress Test Summary and Results

Test Item	Test Condition	Time Point	Total Sample Size	Number of Failures	Reference Standard
HTOL	T _J = 125°C, V _{IN} = V _{ccmax}	168 / 500 / 1000 hours	231 pcs	0	JESD22-A108
Preconditioning (Note A)	T _A = 30°C, RH = 60% + 3 cycle reflow @ 260°C (MSL 3)	192 hours	1155 pcs	0	JESD22-A113
HAST	T _A = 130°C, RH = 85%, P = 33.3psia, V _{IN} = V _{ccmax}	96 hours	231 pcs	0	JESD22-A110
THB	T _A = 85°C, RH = 85%, V _{IN} = V _{ccmax}	168 / 500 / 1000 hours	231 pcs	0	JESD22-A101
Autoclave	T _A = 121°C, RH = 100%, P = 29.7psia	96 hours	231 pcs	0	JESD22-A102
Temperature Cycle	T _A = -65°C to 150°C, air to air	250 / 500 / 1000 cycles	231 pcs	0	JESD22-A104
HTSL	Temp = 150°C	168 / 500 / 1000 hours	231 pcs	0	JESD22-A103

Note: The reliability data presents total of available generic data up to the published date.

Note A: MSL (Moisture Sensitivity Level) 3 based on J-STD-020

II. Reliability Evaluation

FIT rate (per billion): 50.97

MTTF = 2240 years

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

Failure Rate = $\text{Chi}^2 \times 10^9 / [2 (N) (H) (Af)] = 50.97$

MTTF = $10^9 / \text{FIT} = 2240 \text{ years}$

Chi² = Chi Squared Distribution, determined by the number of failures and confidence interval

N = Total Number of units from burn-in tests

H = Duration of burn-in testing

Af = Acceleration Factor from Test to Use Conditions (E_a = 0.7eV and T_{use} = 55°C)

Acceleration Factor **[Af]** = **Exp** [E_a / k (1/T_{J u} - 1/T_{J s})]

